Welcome to [E-XFL.COM](#)**Understanding Embedded - FPGAs (Field Programmable Gate Array)**

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details

Product Status	Obsolete
Number of LABs/CLBs	-
Number of Logic Elements/Cells	19700
Total RAM Bits	434176
Number of I/O	400
Number of Gates	-
Voltage - Supply	1.14V ~ 1.26V
Mounting Type	Surface Mount
Operating Temperature	-40°C ~ 100°C (TJ)
Package / Case	672-BBGA
Supplier Device Package	672-FPBGA (27x27)
Purchase URL	https://www.e-xfl.com/product-detail/lattice-semiconductor/lfec20e-3fn672i

Figure 2-1. Simplified Block Diagram, LatticeEC Device (Top Level)

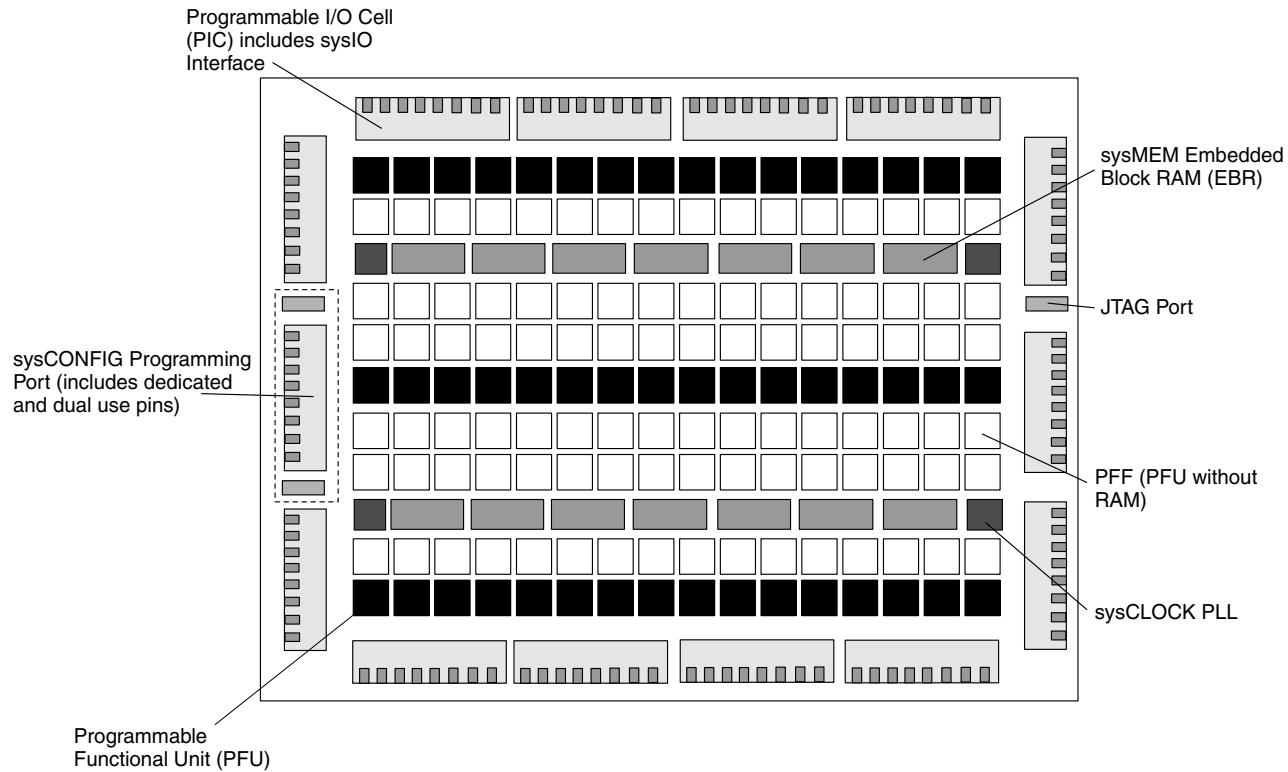
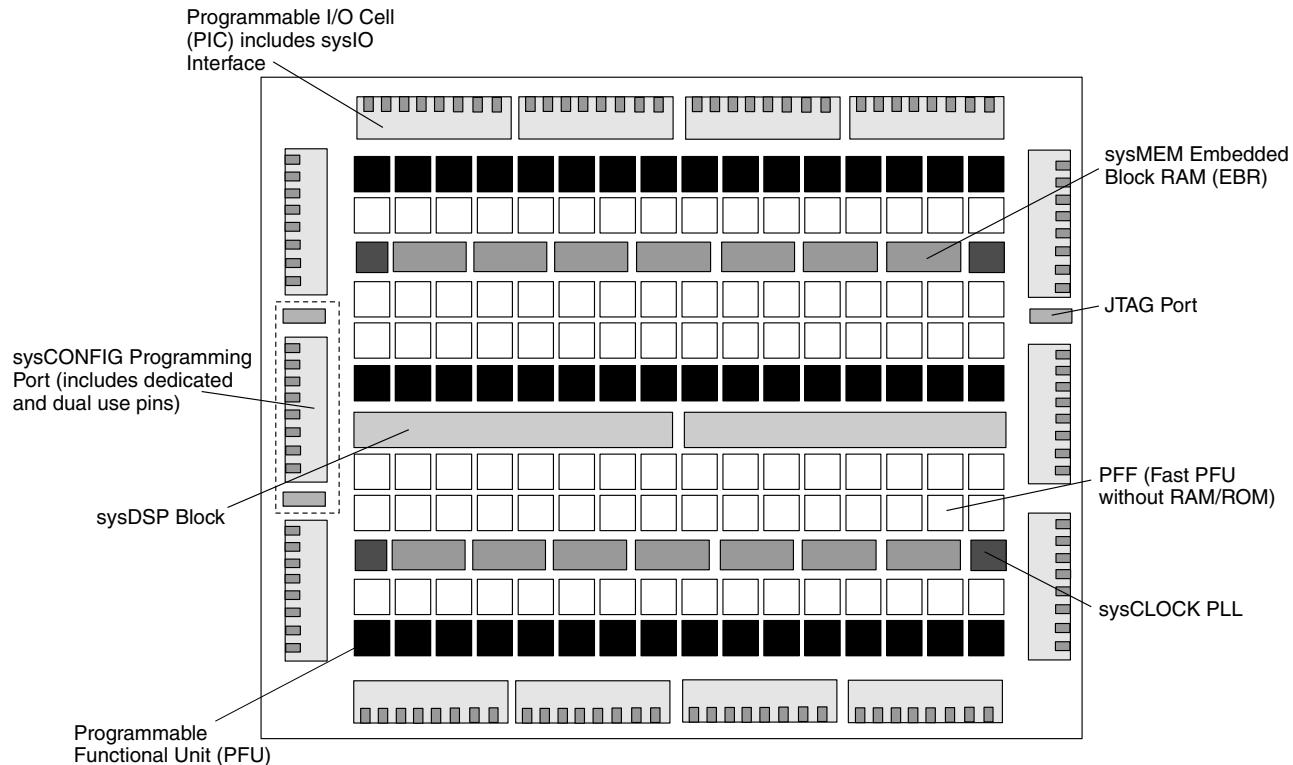


Figure 2-2. Simplified Block Diagram, LatticeECP-DSP Device (Top Level)

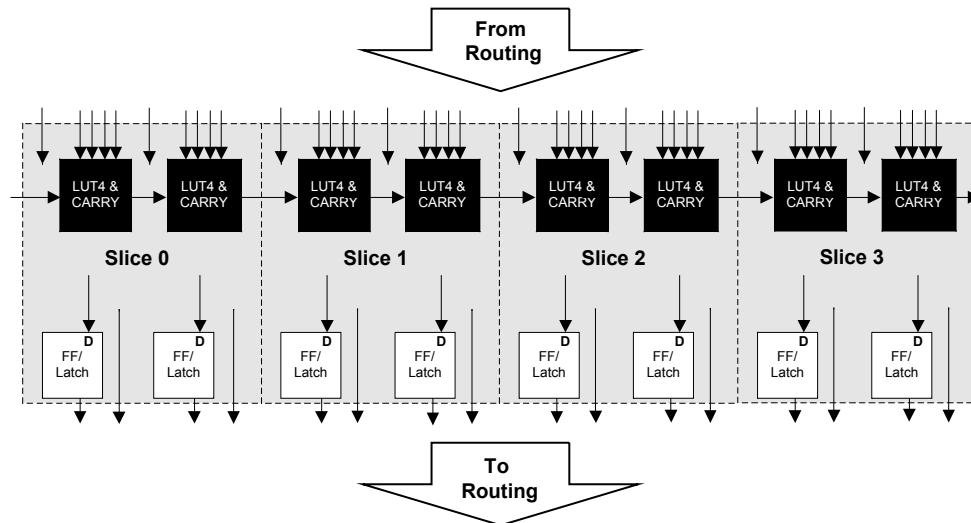


PFU and PFF Blocks

The core of the LatticeECP/EC devices consists of PFU and PFF blocks. The PFUs can be programmed to perform Logic, Arithmetic, Distributed RAM and Distributed ROM functions. PFF blocks can be programmed to perform Logic, Arithmetic and ROM functions. Except where necessary, the remainder of the data sheet will use the term PFU to refer to both PFU and PFF blocks.

Each PFU block consists of four interconnected slices, numbered 0-3 as shown in Figure 2-3. All the interconnections to and from PFU blocks are from routing. There are 53 inputs and 25 outputs associated with each PFU block.

Figure 2-3. PFU Diagram



Slice

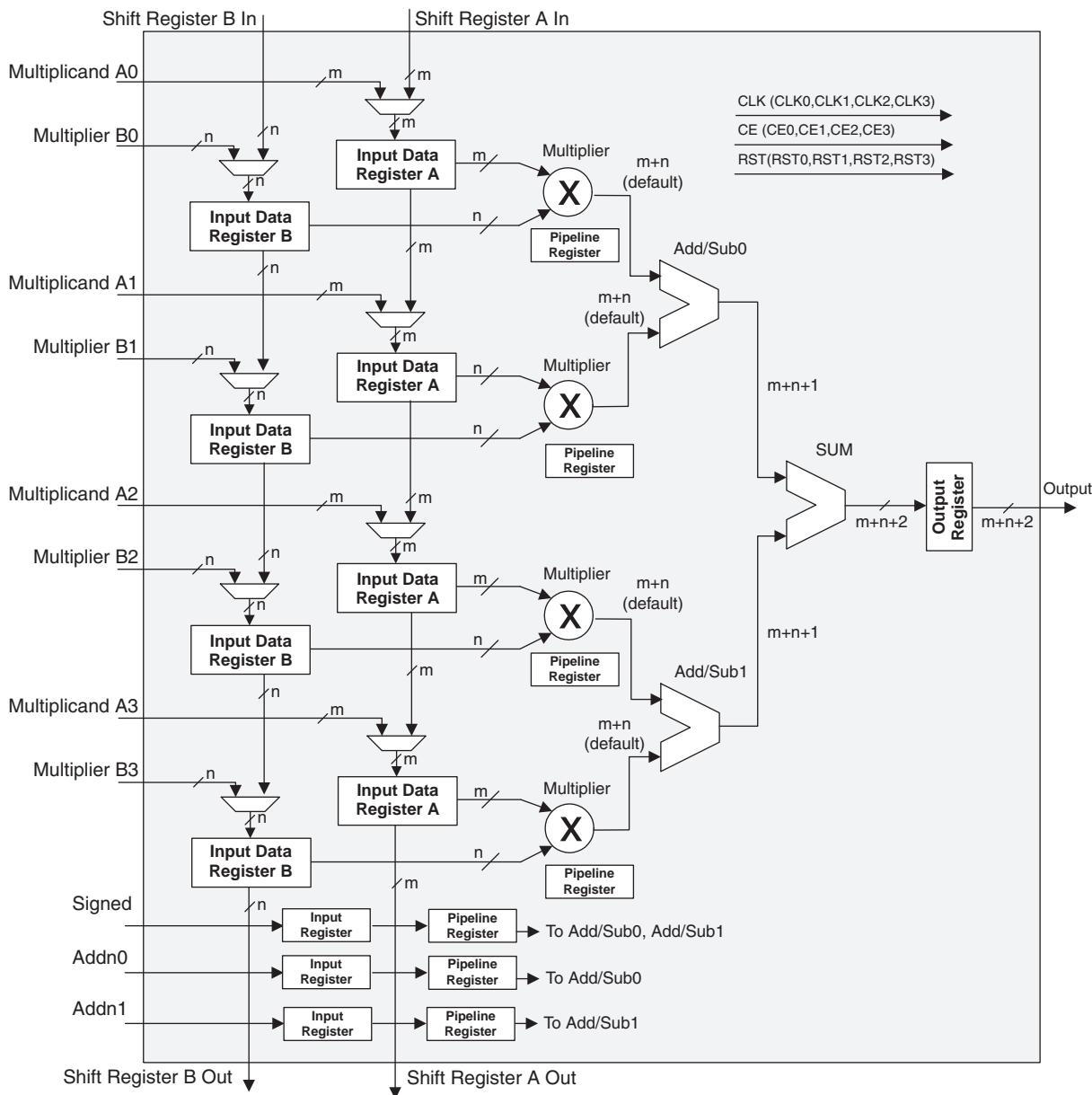
Each slice contains two LUT4 lookup tables feeding two registers (programmed to be in FF or Latch mode), and some associated logic that allows the LUTs to be combined to perform functions such as LUT5, LUT6, LUT7 and LUT8. There is control logic to perform set/reset functions (programmable as synchronous/asynchronous), clock select, chip-select and wider RAM/ROM functions. Figure 2-4 shows an overview of the internal logic of the slice. The registers in the slice can be configured for positive/negative and edge/level clocks.

There are 14 input signals: 13 signals from routing and one from the carry-chain (from adjacent slice or PFU). There are 7 outputs: 6 to routing and one to carry-chain (to adjacent PFU). Table 2-1 lists the signals associated with each slice.

MULTADD SUM sysDSP Element

In this case, the operands A0 and B0 are multiplied and the result is added/subtracted with the result of the multiplier operation of operands A1 and B1. Additionally the operands A2 and B2 are multiplied and the result is added/subtracted with the result of the multiplier operation of operands A3 and B3. The result of both addition/subtraction are added in a summation block. The user can enable the input, output and pipeline registers. Figure 2-22 shows the MULTADD SUM sysDSP element.

Figure 2-22. MULTADD SUM



Clock, Clock Enable and Reset Resources

Global Clock, Clock Enable and Reset signals from routing are available to every DSP block. Four Clock, Reset and Clock Enable signals are selected for the sysDSP block. From four clock sources (CLK0, CLK1, CLK2, CLK3) one clock is selected for each input register, pipeline register and output register. Similarly Clock enable (CE) and Reset (RST) are selected from their four respective sources (CE0, CE1, CE2, CE3 and RST0, RST1, RST2, RST3) at each input register, pipeline register and output register.

Polarity Control Logic

In a typical DDR Memory interface design, the phase relation between the incoming delayed DQS strobe and the internal system Clock (during the READ cycle) is unknown.

The LatticeECP/EC family contains dedicated circuits to transfer data between these domains. To prevent setup and hold violations at the domain transfer between DQS (delayed) and the system Clock a clock polarity selector is used. This changes the edge on which the data is registered in the synchronizing registers in the input register block. This requires evaluation at the start of each READ cycle for the correct clock polarity.

Prior to the READ operation in DDR memories DQS is in tristate (pulled by termination). The DDR memory device drives DQS low at the start of the preamble state. A dedicated circuit detects this transition. This signal is used to control the polarity of the clock to the synchronizing registers.

sysI/O Buffer

Each I/O is associated with a flexible buffer referred to as a sysI/O buffer. These buffers are arranged around the periphery of the device in eight groups referred to as Banks. The sysI/O buffers allow users to implement the wide variety of standards that are found in today's systems including LVCMOS, SSTL, HSTL, LVDS and LVPECL.

sysI/O Buffer Banks

LatticeECP/EC devices have eight sysI/O buffer banks; each is capable of supporting multiple I/O standards. Each sysI/O bank has its own I/O supply voltage (V_{CCIO}), and two voltage references V_{REF1} and V_{REF2} resources allowing each bank to be completely independent from each other. Figure 2-34 shows the eight banks and their associated supplies.

In the LatticeECP/EC devices, single-ended output buffers and ratioed input buffers (LVTTL, LVCMOS, PCI and PCI-X) are powered using V_{CCIO} . LVTTL, LVCMOS33, LVCMOS25 and LVCMOS12 can also be set as fixed threshold input independent of V_{CCIO} . In addition to the bank V_{CCIO} supplies, the LatticeECP/EC devices have a V_{CC} core logic power supply, and a V_{CCAUX} supply that power all differential and referenced buffers.

Each bank can support up to two separate VREF voltages, VREF1 and VREF2 that set the threshold for the referenced input buffers. In the LatticeECP/EC devices, some dedicated I/O pins in a bank can be configured to be a reference voltage supply pin. Each I/O is individually configurable based on the bank's supply and reference voltages.

Oscillator

Every LatticeECP/EC device has an internal CMOS oscillator which is used to derive a master clock for configuration. The oscillator and the master clock run continuously. The default value of the master clock is 2.5MHz. Table 2-15 lists all the available Master Clock frequencies. When a different Master Clock is selected during the design process, the following sequence takes place:

1. User selects a different Master Clock frequency.
2. During configuration the device starts with the default (2.5MHz) Master Clock frequency.
3. The clock configuration settings are contained in the early configuration bit stream.
4. The Master Clock frequency changes to the selected frequency once the clock configuration bits are received.

For further information about the use of this oscillator for configuration, please see the list of technical documentation at the end of this data sheet.

Table 2-15. Selectable Master Clock (CCLK) Frequencies During Configuration

CCLK (MHz)	CCLK (MHz)	CCLK (MHz)
2.5*	13	45
4.3	15	51
5.4	20	55
6.9	26	60
8.1	30	130
9.2	34	—
10.0	41	—

Density Shifting

The LatticeECP/EC family has been designed to ensure that different density devices in the same package have the same pin-out. Furthermore, the architecture ensures a high success rate when performing design migration from lower density parts to higher density parts. In many cases, it is also possible to shift a lower utilization design targeted for a high-density device to a lower density device. However, the exact details of the final resource utilization will impact the likely success in each case.



LatticeECP/EC Family Data Sheet

DC and Switching Characteristics

September 2012

Data Sheet

Absolute Maximum Ratings^{1, 2, 3}

Supply Voltage V _{CC}	-0.5 to 1.32V
Supply Voltage V _{CCAUX}	-0.5 to 3.75V
Supply Voltage V _{CCJ}	-0.5 to 3.75V
Output Supply Voltage V _{CCIO}	-0.5 to 3.75V
Dedicated Input Voltage Applied ⁴	-0.5 to 4.25V
I/O Tristate Voltage Applied ⁴	-0.5 to 3.75V
Storage Temperature (Ambient)	-65 to 150°C
Junction Temp. (T _j)	+125°C

1. Stress above those listed under the "Absolute Maximum Ratings" may cause permanent damage to the device. Functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied.
2. Compliance with the Lattice *Thermal Management* document is required.
3. All voltages referenced to GND.
4. Overshoot and undershoot of -2V to (V_{IHMAX} + 2) volts is permitted for a duration of <20ns.

Recommended Operating Conditions

Symbol	Parameter	Min.	Max.	Units
V _{CC}	Core Supply Voltage	1.14	1.26	V
V _{CCAUX} ³	Auxiliary Supply Voltage	3.135	3.465	V
V _{CCPLL}	PLL Supply Voltage for ECP/EC33	1.14	1.26	V
V _{CCIO} ^{1, 2}	I/O Driver Supply Voltage	1.140	3.465	V
V _{CCJ} ¹	Supply Voltage for IEEE 1149.1 Test Access Port	1.140	3.465	V
t _{JCOM}	Junction Commercial Operation	0	85	°C
t _{JIND}	Junction Industrial Operation	-40	100	°C

1. If V_{CCIO} or V_{CCJ} is set to 1.2V, they must be connected to the same power supply as V_{CC}. If V_{CCIO} or V_{CCJ} is set to 3.3V, they must be connected to the same power supply as V_{CCAUX}.
2. See recommended voltages by I/O standard in subsequent table.
3. V_{CCAUX} ramp rate must not exceed 3mV/μs for commercial and 0.6 mV/μs for industrial device operations during power up when transitioning between 0.8V and 1.8V.

Hot Socketing Specifications^{1, 2, 3, 4}

Symbol	Parameter	Condition	Min.	Typ.	Max.	Units
Top and Bottom General Purpose sysI/Os (Banks 0, 1, 4 and 5), JTAG and Dedicated sysCONFIG Pins						
I _{DK_TB}	Input or I/O Leakage Current	0 ≤ V _{IN} ≤ V _{IH} (MAX.)	—	—	+/-1000	μA
Left and Right General Purpose sysI/Os (Banks 2, 3, 6 and 7)						
I _{DK_LR}	Input or I/O Leakage Current	V _{IN} ≤ V _{CCIO}	—	—	+/-1000	μA
		V _{IN} > V _{CCIO}	—	35	—	mA

1. Insensitive to sequence of V_{CC}, V_{CCAUX} and V_{CCIO}. However, assumes monotonic rise/fall rates for V_{CC}, V_{CCAUX} and V_{CCIO}.
2. 0 ≤ V_{CC} ≤ V_{CC} (MAX), 0 ≤ V_{CCIO} ≤ V_{CCIO} (MAX) or 0 ≤ V_{CCAUX} ≤ V_{CCAUX} (MAX).
3. I_{DK} is additive to I_{PU}, I_{PW} or I_{BH}.
4. LVCMOS and LVTTL only.

sysCLOCK PLL Timing

Over Recommended Operating Conditions

Parameter	Description	Conditions	Min.	Typ.	Max.	Units
f_{IN}	Input Clock Frequency (CLKI, CLKFB)		25	—	420	MHz
f_{OUT}	Output Clock Frequency (CLKOP, CLKOS)		25	—	420	MHz
f_{OUT2}	K-Divider Output Frequency (CLKOK)		0.195	—	210	MHz
f_{VCO}	PLL VCO Frequency		420	—	840	MHz
f_{PFD}	Phase Detector Input Frequency		25	—	—	MHz
AC Characteristics						
t_{DT}	Output Clock Duty Cycle	Default Duty Cycle Elected ³	45	50	55	%
t_{PH}^4	Output Phase Accuracy		—	—	0.05	UI
t_{OPJIT}^1	Output Clock Period Jitter	$f_{OUT} \geq 100\text{MHz}$	—	—	+/- 125	ps
		$f_{OUT} < 100\text{MHz}$	—	—	0.02	UIPP
t_{SK}	Input Clock to Output Clock Skew	Divider ratio = integer	—	—	+/- 200	ps
t_W	Output Clock Pulse Width	At 90% or 10% ³	1	—	—	ns
t_{LOCK}^2	PLL Lock-in Time		—	—	150	μs
t_{PA}	Programmable Delay Unit		100	250	450	ps
t_{IPJIT}	Input Clock Period Jitter		—	—	+/- 200	ps
t_{FBKDLY}	External Feedback Delay		—	—	10	ns
t_{HI}	Input Clock High Time	90% to 90%	0.5	—	—	ns
t_{LO}	Input Clock Low Time	10% to 10%	0.5	—	—	ns
t_{RST}	RST Pulse Width		10	—	—	ns

1. Jitter sample is taken over 10,000 samples of the primary PLL output with clean reference clock.

2. Output clock is valid after t_{LOCK} for PLL reset and dynamic delay adjustment.

3. Using LVDS output buffers.

4. Relative to CLKOP.

Timing v.G 0.30

LatticeECP/EC sysCONFIG Port Timing Specifications

Over Recommended Operating Conditions

Parameter	Description	Min.	Typ.	Max.	Units
sysCONFIG Byte Data Flow					
t_{SUCBDI}	Byte D[0:7] Setup Time to CCLK	7		—	ns
t_{HCBDI}	Byte D[0:7] Hold Time to CCLK	1		—	ns
t_{CODO}	Clock to Dout in Flowthrough Mode	—		12	ns
t_{SUCS}	CS[0:1] Setup Time to CCLK	7		—	ns
t_{HCS}	CS[0:1] Hold Time to CCLK	1		—	ns
t_{SUWD}	Write Signal Setup Time to CCLK	7		—	ns
t_{HWD}	Write Signal Hold Time to CCLK	1		—	ns
t_{DCB}	CCLK to BUSY Delay Time	—		12	ns
t_{CORD}	Clock to Out for Read Data	—		12	ns
sysCONFIG Byte Slave Clocking					
t_{BSCH}	Byte Slave Clock Minimum High Pulse	6		—	ns
t_{BSCL}	Byte Slave Clock Minimum Low Pulse	9		—	ns
t_{BSCYC}	Byte Slave Clock Cycle Time	15		—	ns
t_{SUSCDI}	Din Setup time to CCLK Slave Mode	7		—	ns
t_{HSCDI}	Din Hold Time to CCLK Slave Mode	1		—	ns
t_{CODO}	Clock to Dout in Flowthrough Mode	—		12	ns
sysCONFIG Serial (Bit) Data Flow					
t_{SUMCDI}	Din Setup time to CCLK Master Mode	7		—	ns
t_{HMCDI}	Din Hold Time to CCLK Master Mode	1		—	ns
sysCONFIG Serial Slave Clocking					
t_{SSCH}	Serial Slave Clock Minimum High Pulse	6		—	ns
t_{SSCL}	Serial Slave Clock Minimum Low Pulse	6		—	ns
sysCONFIG POR, Initialization and Wake Up					
t_{ICFG}	Minimum Vcc to INIT High	—		50	ms
t_{VMC}	Time from tICFG to Valid Master Clock	—		2	us
t_{PRGMRJ}	Program Pin Pulse Rejection	—		8	ns
t_{PRGM}	PROGRAMN Low Time to Start Configuration	25		—	ns
t_{DINIT}	INIT Low Time	—		1	ms
$t_{DPPINIT}$	Delay Time from PROGRAMN Low to INIT Low	—		37	ns
t_{DINITD}	Delay Time from PROGRAMN Low to DONE Low	—		37	ns
t_{IODISS}	User I/O Disable from PROGRAMN Low	—		35	ns
t_{IOENSS}	User I/O Enabled Time from CCLK Edge During Wake Up Sequence	—		25	ns
t_{MWC}	Additional Wake Master Clock Signals after Done Pin High	120		—	cycles
t_{SUCFG}	CFG to INITN Setup Time	100		—	ns
t_{HCFG}	CFG to INITN Hold Time	100		—	ns
sysCONFIG SPI Port					
t_{CFGX}	Init High to CCLK Low	—		80	ns
t_{CSSPI}	Init High to CSSPIN Low	—		2	us
t_{CSCCLK}	CCLK Low Before CSSPIN Low	0		-	ns
t_{SOCDO}	CCLK Low to Output Valid	—		15	ns

LatticeECP/EC sysCONFIG Port Timing Specifications (Continued)

Over Recommended Operating Conditions

Parameter	Description	Min.	Typ.	Max.	Units
t_{SOE}	CSSPIN Active Setup Time	300		—	ns
t_{CSPID}	CSSPIN Low to First Clock Edge Setup Time	300+3cyc		600+6cyc	ns
f_{MAXSPI}	Max Frequency for SPI	—		25	MHz
t_{SUSPI}	SOSPI Data Setup Time Before CCLK	7		—	ns
t_{HSPI}	SOSPI Data Hold Time After CCLK	1		—	ns

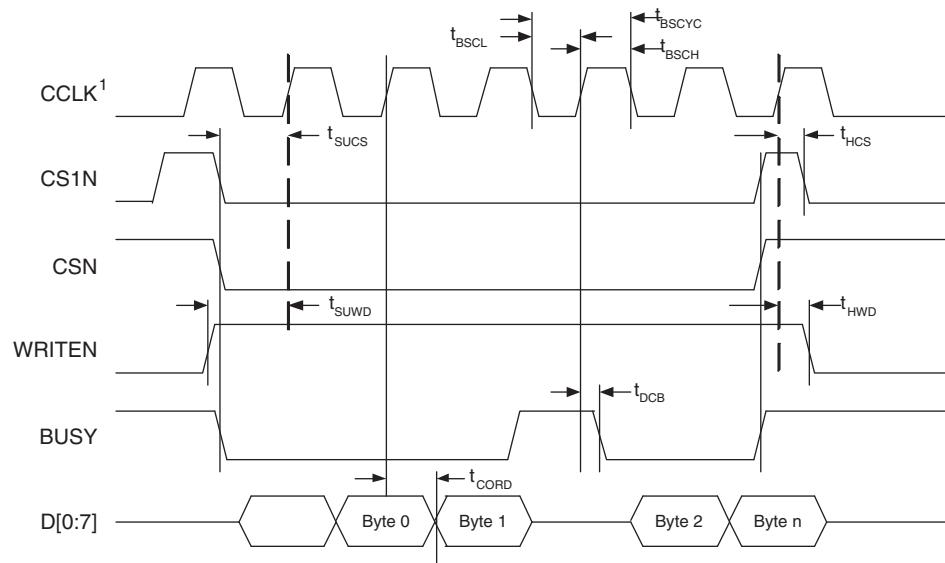
Timing v.G 0.30

Master Clock

Clock Mode	Min.	Typ.	Max.	Units
2.5MHz	1.75	2.5	3.25	MHz
5 MHz	3.78	5.4	7.02	MHz
10 MHz	7	10	13	MHz
15 MHz	10.5	15	19.5	MHz
20 MHz	14	20	26	MHz
25 MHz	18.2	26	33.8	MHz
30 MHz	21	30	39	MHz
35 MHz	23.8	34	44.2	MHz
40 MHz	28.7	41	53.3	MHz
45 MHz	31.5	45	58.5	MHz
50 MHz	35.7	51	66.3	MHz
55 MHz	38.5	55	71.5	MHz
60 MHz	42	60	78	MHz
Duty Cycle	40	—	60	%

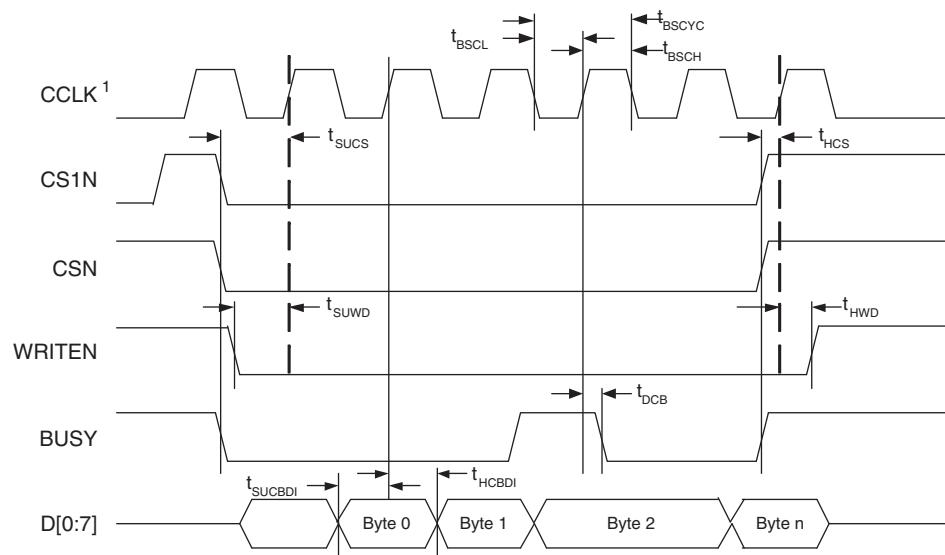
Timing v.G 0.30

Figure 3-12. sysCONFIG Parallel Port Read Cycle



1. In Master Parallel Mode the FPGA provides CCLK. In Slave Parallel Mode the external device provides CCLK.

Figure 3-13. sysCONFIG Parallel Port Write Cycle



1. In Master Parallel Mode the FPGA provides CCLK. In Slave Parallel Mode the external device provides CCLK.

Pin Information Summary

		LFEC1			LFEC3				LFECP6/EC6				LFECP/EC10		
Pin Type		100-TQFP	144-TQFP	208-PQFP	100-TQFP	144-TQFP	208-PQFP	256-fpBGA	144-TQFP	208-PQFP	256-fpBGA	484-fpBGA	208-PQFP	256-fpBGA	484-fpBGA
Single Ended User I/O		67	97	112	67	97	145	160	97	147	195	224	147	195	288
Differential Pair User I/O		29	46	56	29	46	72	80	46	72	97	112	72	97	144
Configuration	Dedicated	13	13	13	13	13	13	13	13	13	13	13	13	13	13
	Muxed	48	48	48	48	48	48	48	48	48	48	48	56	56	56
TAP		5	5	5	5	5	5	5	5	5	5	5	5	5	5
Dedicated (total without supplies)		80	110	160	80	110	160	208	110	160	208	373	160	208	373
V _{CC}		2	3	3	2	3	3	10	4	4	10	20	6	10	20
V _{CCAUX}		2	2	2	4	4	4	4	2	4	2	12	4	2	12
V _{CCPLL}		0	0	0	0	0	0	0	0	0	0	0	0	0	0
V _{CCIO}	Bank0	1	2	2	1	2	3	2	2	3	2	4	3	2	4
	Bank1	1	2	2	1	2	2	2	2	2	2	4	2	2	4
	Bank2	1	1	1	2	2	2	2	1	2	2	4	2	2	4
	Bank3	1	2	2	1	2	2	2	2	2	2	4	2	2	4
	Bank4	1	2	2	1	2	2	2	2	2	2	4	2	2	4
	Bank5	1	2	2	1	2	2	2	2	3	2	4	3	2	4
	Bank6	1	2	2	1	2	2	2	2	2	2	4	2	2	4
	Bank7	1	1	1	2	2	2	2	1	2	2	4	2	2	4
GND, GND0-GND7		8	13	13	8	13	16	20	14	18	20	44	20	20	44
NC		0	2	51	0	2	9	35	0	4	0	139	0	0	75
Single Ended/Differential I/O Pair per Bank	Bank 0	11/5	14/7	16/8	11/5	14/7	26/13	32/16	14/7	26/13	32/16	32/16	26/13	32/16	48/24
	Bank 1	11/5	13/6	16/8	11/5	13/6	16/8	16/8	13/6	17/8	18/9	32/16	17/8	18/9	32/16
	Bank 2	3/1	8/4	8/4	3/1	8/4	14/7	16/8	8/4	14/7	16/8	16/8	14/7	16/8	32/16
	Bank 3	8/4	13/6	16/8	8/4	13/6	16/8	16/8	13/6	16/8	32/16	32/16	16/8	32/16	32/16
	Bank 4	12/4	14/6	16/8	12/4	14/6	16/8	16/8	14/6	17/8	17/8	32/16	17/8	17/8	32/16
	Bank 5	9/4	13/6	16/8	9/4	13/6	26/13	32/16	13/6	26/13	32/16	32/16	26/13	32/16	48/24
	Bank 6	5/2	14/7	16/8	5/2	14/7	16/8	16/8	14/7	16/8	32/16	32/16	16/8	32/16	32/16
	Bank 7	8/4	8/4	8/4	8/4	8/4	15/7	16/8	8/4	15/7	16/8	16/8	15/7	16/8	32/16
V _{CCJ}		1	1	1	1	1	1	1	1	1	1	1	1	1	1

Note: During configuration the user-programmable I/Os are tri-stated with an internal pull-up resistor enabled. If any pin is not used (or not bonded to a package pin), it is also tri-stated with an internal pull-up resistor enabled after configuration.

Power Supply and NC Connections

Signals	100 TQFP	144 TQFP	208 PQFP	256 fpBGA
VCC	12, 64	EC1, EC3: 13, 92, 99 ECP/EC6: 11, 13, 92, 99	EC1, EC3: 26, 128, 135 ECP/EC6: 24, 26, 128, 135 ECP/EC10: 5, 24, 26, 128, 135, 152	E12, E5, E8, M12, M5, M9, F6, F11, L11, L6
VCCIO0	100	136, 143	EC1: 187, 208 EC3, ECP/EC6, ECP/EC10: 187, 197, 208	F7, F8
VCCIO1	86	110, 125	157, 176	F9, F10
VCCIO2	73	108	EC1: 155 EC3, ECP/EC6, ECP/EC10: 145, 155	G11, H11
VCCIO3	56	73, 84	106, 120	J11, K11
VCCIO4	38	55, 71	85, 104	L9, L10
VCCIO5	26	38, 44	EC1: 53, 74 EC2, ECP/EC6, ECP/EC10: 53, 64, 74	L7, L8
VCCIO6	24	24, 36	37, 51	J6, K6
VCCIO7	2	1	EC1: 2 EC3, ECP/EC6, ECP/EC10: 2, 13	G6, H6
VCCJ	18	19	32	L4
VCCAUX	37, 87	54, 126	EC1: 84, 177 EC3, ECP/EC6, ECP/EC10: 22, 84, 136, 177	B15, R2
VCCPLL	—	—	—	—
GND, GND0-GND7	1, 14, 25, 35, 51, 68, 74, 89	EC1, EC3: 15, 28, 37, 52, 63, 72, 80, 96, 98, 109, 117, 128, 144 ECP/EC6: 12, 15, 28, 37, 52, 63, 72, 80, 96, 98, 109, 117, 128, 144	EC1: 1, 28, 41, 52, 82, 93, 105, 116, 132, 134, 156, 168, 179 EC3: 1, 28, 41, 52, 72, 82, 93, 105, 116, 132, 134, 138, 156, 168, 179, 189 ECP/EC6: 1, 18, 25, 28, 41, 52, 72, 82, 93, 105, 116, 132, 134, 138, 156, 168, 179, 189 ECP/EC10: 1, 6, 18, 25, 28, 41, 52, 72, 82, 93, 105, 116, 132, 134, 138, 151, 156, 168, 179, 189	A1, A16, G10, G7, G8, G9, H10, H7, H8, H9, J10, J7, J8, J9, K10, K7, K8, K9, T1, T16
NC	—	EC1, EC3: 11, 12 ECP6/EC6: None	EC1: 5, 6, 7, 8, 9, 10, 11, 12, 13, 14, 18, 22, 24, 25, 54, 55, 56, 57, 58, 59, 60, 61, 62, 63, 64, 72, 103, 136, 138, 144, 145, 146, 147, 148, 149, 150, 151, 152, 158, 189, 197, 198, 199, 200, 201, 202, 203, 204, 205, 206, 207 EC3: 5, 6, 18, 24, 25, 103, 151, 152, 158 ECP/EC6: 5, 6, 151, 152 ECP/EC10: None	EC3: G5, H5, F2, F1, H4, H3, G2, G1, J4, J3, J5, K5, H2, H1, J2, J1, R12, H16, H15, G16, G15, K12, J12, J14, J15, F16, F15, J13, H13, H14, G14, E16, E15, B13, C13 ECP/EC10: None ECP/EC15: None

LFEC1, LFEC3 Logic Signal Connections: 100 TQFP (Cont.)

Pin Number	LFEC1					LFEC3			
	Pin Function	Bank	LVDS	Dual Function		Pin Function	Bank	LVDS	Dual Function
41	PB11A	4	T	VREF1_4		PB19A	4	T	VREF1_4
42	PB11B	4	C	CSN		PB19B	4	C	CSN
43	PB12B	4		D0/SPID7		PB20B	4		D0/SPID7
44	PB13A	4	T	D2/SPID5		PB21A	4	T	D2/SPID5
45	PB13B	4	C	D1/SPID6		PB21B	4	C	D1/SPID6
46	PB14A	4	T	BDQS14		PB22A	4	T	BDQS22
47	PB14B	4	C	D3/SPID4		PB22B	4	C	D3/SPID4
48	PB15B	4		D4/SPID3		PB23B	4		D4/SPID3
49	PB16B	4		D5/SPID2		PB24B	4		D5/SPID2
50	PB17B	4		D6/SPID1		PB25B	4		D6/SPID1
51*	GND3 GND4	-				GND3 GND4	-		
52	PR10B	3	C	RLM0_PLLC_FB_A		PR14B	3	C	RLM0_PLLC_FB_A
53	PR10A	3	T	RLM0_PLLT_FB_A		PR14A	3	T	RLM0_PLLT_FB_A
54	PR9B	3	C	RLM0_PLLC_IN_A		PR13B	3	C	RLM0_PLLC_IN_A
55	PR9A	3	T	RLM0_PLLT_IN_A		PR13A	3	T	RLM0_PLLT_IN_A
56	VCCIO3	3				VCCIO3	3		
57	PR8B	3	C	DI/CSSPIN		PR12B	3	C	DI/CSSPIN
58	PR8A	3	T	DOUT/CSON		PR12A	3	T	DOUT/CSON
59	PR7B	3	C	BUSY/SISPI		PR11B	3	C	BUSY/SISPI
60	PR7A	3	T	D7/SPID0		PR11A	3	T	D7/SPID0
61	CFG2	3				CFG2	3		
62	CFG1	3				CFG1	3		
63	CFG0	3				CFG0	3		
64	VCC	-				VCC	-		
65	PROGRAMN	3				PROGRAMN	3		
66	CCLK	3				CCLK	3		
67	INITN	3				INITN	3		
68	GND	-				GND	-		
69	DONE	3				DONE	3		
70	PR5B	2	C	PCLKC2_0		PR9B	2	C	PCLKC2_0
71	PR5A	2	T	PCLKT2_0		PR9A	2	T	PCLKT2_0
72	PR2B	2		VREF1_2		PR2B	2		VREF1_2
73	VCCIO2	2				VCCIO2	2		
74	GND2	2				GND2	2		
75	PT17B	1	C			PT25B	1	C	
76	PT17A	1	T			PT25A	1	T	
77	PT14B	1	C			PT22B	1	C	
78	PT14A	1	T	TDQS14		PT22A	1	T	TDQS22
79	PT13A	1				PT21A	1		
80	PT12B	1	C			PT20B	1	C	
81	PT12A	1	T			PT20A	1	T	

LFECP/EC6, LFECP/EC10 Logic Signal Connections: 208 PQFP (Cont.)

Pin Number	LFECP6/LFEC6					LFECP10/LFEC10			
	Pin Function	Bank	LVDS	Dual Function		Pin Function	Bank	LVDS	Dual Function
169	PT21A	1	T			PT29A	1	T	
170	PT20B	1	C			PT28B	1	C	
171	PT20A	1	T			PT28A	1	T	
172	PT19B	1	C	VREF2_1		PT27B	1	C	VREF2_1
173	PT19A	1	T	VREF1_1		PT27A	1	T	VREF1_1
174	PT18B	1	C			PT26B	1	C	
175	PT18A	1	T			PT26A	1	T	
176	VCCIO1	1				VCCIO1	1		
177	VCCAUX	-				VCCAUX	-		
178	PT17B	0	C	PCLKC0_0		PT25B	0	C	PCLKC0_0
179	GND0	0				GND0	0		
180	PT17A	0	T	PCLKT0_0		PT25A	0	T	PCLKT0_0
181	PT16B	0	C	VREF1_0		PT24B	0	C	VREF1_0
182	PT16A	0	T	VREF2_0		PT24A	0	T	VREF2_0
183	PT15B	0	C			PT23B	0	C	
184	PT15A	0	T			PT23A	0	T	
185	PT14B	0	C			PT22B	0	C	
186	PT14A	0	T	TDQS14		PT22A	0	T	TDQS22
187	VCCIO0	0				VCCIO0	0		
188	PT13B	0	C			PT21B	0	C	
189	GND0	0				GND0	0		
190	PT13A	0	T			PT21A	0	T	
191	PT12B	0	C			PT20B	0	C	
192	PT12A	0	T			PT20A	0	T	
193	PT11B	0	C			PT19B	0	C	
194	PT11A	0	T			PT19A	0	T	
195	PT10B	0	C			PT18B	0	C	
196	PT10A	0	T			PT18A	0	T	
197	VCCIO0	0				VCCIO0	0		
198	PT6B	0	C			PT6B	0	C	
199	PT6A	0	T	TDQS6		PT6A	0	T	TDQS6
200	PT5B	0	C			PT5B	0	C	
201	PT5A	0	T			PT5A	0	T	
202	PT4B	0	C			PT4B	0	C	
203	PT4A	0	T			PT4A	0	T	
204	PT3B	0	C			PT3B	0	C	
205	PT3A	0	T			PT3A	0	T	
206	PT2B	0	C			PT2B	0	C	
207	PT2A	0	T			PT2A	0	T	
208	VCCIO0	0				VCCIO0	0		

*Double bonded to the pin.

LFEC3 and LFECP/EC6 Logic Signal Connections: 256 fpBGA (Cont.)

Ball Number	LFEC3				LFECP6/LFEC6			
	Ball Function	Bank	LVDS	Dual Function	Ball Function	Bank	LVDS	Dual Function
D7	PT11B	0	C		PT11B	0	C	
C7	PT11A	0	T		PT11A	0	T	
A7	PT10B	0	C		PT10B	0	C	
A6	PT10A	0	T		PT10A	0	T	
E7	PT9B	0	C		PT9B	0	C	
GND	GND0	0			GND0	0		
E6	PT9A	0	T		PT9A	0	T	
D6	PT8B	0	C		PT8B	0	C	
C6	PT8A	0	T		PT8A	0	T	
B6	PT7B	0	C		PT7B	0	C	
B5	PT7A	0	T		PT7A	0	T	
A5	PT6B	0	C		PT6B	0	C	
A4	PT6A	0	T	TDQS6	PT6A	0	T	TDQS6
A3	PT5B	0	C		PT5B	0	C	
A2	PT5A	0	T		PT5A	0	T	
B2	PT4B	0	C		PT4B	0	C	
B3	PT4A	0	T		PT4A	0	T	
D5	PT3B	0	C		PT3B	0	C	
C5	PT3A	0	T		PT3A	0	T	
C4	PT2B	0	C		PT2B	0	C	
B4	PT2A	0	T		PT2A	0	T	
GND	GND0	0			GND0	0		
A1	GND	-			GND	-		
A16	GND	-			GND	-		
G10	GND	-			GND	-		
G7	GND	-			GND	-		
G8	GND	-			GND	-		
G9	GND	-			GND	-		
H10	GND	-			GND	-		
H7	GND	-			GND	-		
H8	GND	-			GND	-		
H9	GND	-			GND	-		
J10	GND	-			GND	-		
J7	GND	-			GND	-		
J8	GND	-			GND	-		
J9	GND	-			GND	-		
K10	GND	-			GND	-		
K7	GND	-			GND	-		
K8	GND	-			GND	-		
K9	GND	-			GND	-		
T1	GND	-			GND	-		
T16	GND	-			GND	-		
E12	VCC	-			VCC	-		

LFECP/EC20 and LFECP/EC33 Logic Signal Connections: 484 fpBGA (Cont.)

LFECP20/LFEC20					LFECP/LFEC33				
Ball Number	Ball Function	Bank	LVD S	Dual Function	Ball Number	Ball Function	Bank	LVD S	Dual Function
W20	PR48B	3	C	VREF2_3	W20	PR68B	3	C	VREF2_3
Y20	PR48A	3	T	VREF1_3	Y20	PR68A	3	T	VREF1_3
GND	-	-			GND	GND3	3		
GND	-	-			GND	GND3	3		
AA21	PR47B	3	C		AA21	PR59B	3	C	
AB21	PR47A	3	T		AB21	PR59A	3	T	
W19	PR46B	3	C		W19	PR58B	3	C	
V19	PR46A	3	T		V19	PR58A	3	T	
Y21	PR45B	3	C		Y21	PR57B	3	C	
AA22	PR45A	3	T	RDQS45	AA22	PR57A	3	T	RDQS57
V20	PR44B	3	C	RLM0_PLLC_IN_A	V20	PR56B	3	C	RLM0_PLLC_IN_A
GND	GND3	3			GND	GND3	3		
U20	PR44A	3	T	RLM0_PLLT_IN_A	U20	PR56A	3	T	RLM0_PLLT_IN_A
W21	PR43B	3	C	RLM0_PLLC_FB_A	W21	PR55B	3	C	RLM0_PLLC_FB_A
Y22	PR43A	3	T	RLM0_PLLT_FB_A	Y22	PR55A	3	T	RLM0_PLLT_FB_A
V21	PR42B	3	C	DI/CSSPIN	V21	PR54B	3	C	DI/CSSPIN
W22	PR42A	3	T	DOUT/CSON	W22	PR54A	3	T	DOUT/CSON
U21	PR41B	3	C	BUSY/SISPI	U21	PR53B	3	C	BUSY/SISPI
V22	PR41A	3	T	D7/SPID0	V22	PR53A	3	T	D7/SPID0
T19	CFG2	3			T19	CFG2	3		
U19	CFG1	3			U19	CFG1	3		
U18	CFG0	3			U18	CFG0	3		
V18	PROGRAMN	3			V18	PROGRAMN	3		
T20	CCLK	3			T20	CCLK	3		
T21	INITN	3			T21	INITN	3		
R20	DONE	3			R20	DONE	3		
GND	GND3	3			GND	GND3	3		
T18	PR37B	3	C		T18	PR49B	3	C	
R17	PR37A	3	T		R17	PR49A	3	T	
R19	PR36B	3	C		R19	PR48B	3	C	
R18	PR36A	3	T	RDQS36	R18	PR48A	3	T	RDQS48
U22	PR35B	3	C		U22	PR47B	3	C	
GND	GND3	3			GND	GND3	3		
T22	PR35A	3	T		T22	PR47A	3	T	
R21	PR34B	3	C		R21	PR46B	3	C	
R22	PR34A	3	T		R22	PR46A	3	T	
P20	PR33B	3	C		P20	PR45B	3	C	
N20	PR33A	3	T		N20	PR45A	3	T	
P19	PR32B	3	C		P19	PR44B	3	C	
P18	PR32A	3	T		P18	PR44A	3	T	
P21	PR31B	3	C		P21	PR43B	3	C	
GND	GND3	3			GND	GND3	3		
P22	PR31A	3	T		P22	PR43A	3	T	
N21	PR30B	3	C		N21	PR42B	3	C	

LFECP/EC20, LFECP/EC33 Logic Signal Connections: 672 fpBGA (Cont.)

LFECP20/LFECP20					LFECP/EC33				
Ball Number	Ball Function	Bank	LVDS	Dual Function	Ball Number	Ball Function	Bank	LVDS	Dual Function
AF4	PB13B	5	C		AF4	PB13B	5	C	
AE5	PB14A	5	T	BDQS14	AE5	PB14A	5	T	BDQS14
AA9	PB14B	5	C		AA9	PB14B	5	C	
AF5	PB15A	5	T		AF5	PB15A	5	T	
Y10	PB15B	5	C		Y10	PB15B	5	C	
AD6	PB16A	5	T		AD6	PB16A	5	T	
AC10	PB16B	5	C		AC10	PB16B	5	C	
AF6	PB17A	5	T		AF6	PB17A	5	T	
GND	GND5	5			GND	GND5	5		
AE6	PB17B	5	C		AE6	PB17B	5	C	
AF7	PB18A	5	T		AF7	PB18A	5	T	
AB10	PB18B	5	C		AB10	PB18B	5	C	
AE7	PB19A	5	T		AE7	PB19A	5	T	
AD10	PB19B	5	C		AD10	PB19B	5	C	
AD7	PB20A	5	T		AD7	PB20A	5	T	
AA10	PB20B	5	C		AA10	PB20B	5	C	
AF8	PB21A	5	T		AF8	PB21A	5	T	
GND	GND5	5			GND	GND5	5		
AF9	PB21B	5	C		AF9	PB21B	5	C	
AD11	PB22A	5	T	BDQS22	AD11	PB22A	5	T	BDQS22
Y11	PB22B	5	C		Y11	PB22B	5	C	
AE8	PB23A	5	T		AE8	PB23A	5	T	
AC11	PB23B	5	C		AC11	PB23B	5	C	
AF10	PB24A	5	T		AF10	PB24A	5	T	
AB11	PB24B	5	C		AB11	PB24B	5	C	
AE10	PB25A	5	T		AE10	PB25A	5	T	
GND	GND5	5			GND	GND5	5		
AE9	PB25B	5	C		AE9	PB25B	5	C	
AA11	PB26A	5	T		AA11	PB26A	5	T	
Y12	PB26B	5	C		Y12	PB26B	5	C	
AE11	PB27A	5	T		AE11	PB27A	5	T	
AF11	PB27B	5	C		AF11	PB27B	5	C	
AF12	PB28A	5	T		AF12	PB28A	5	T	
AE12	PB28B	5	C		AE12	PB28B	5	C	
AD12	PB29A	5	T		AD12	PB29A	5	T	
GND	GND5	5			GND	GND5	5		
AC12	PB29B	5	C		AC12	PB29B	5	C	
AA12	PB30A	5	T	BDQS30	AA12	PB30A	5	T	BDQS30
AB12	PB30B	5	C		AB12	PB30B	5	C	
AE13	PB31A	5	T		AE13	PB31A	5	T	
AF13	PB31B	5	C		AF13	PB31B	5	C	
AD13	PB32A	5	T	VREF2_5	AD13	PB32A	5	T	VREF2_5

LFECP/EC20, LFECP/EC33 Logic Signal Connections: 672 fpBGA (Cont.)

LFECP20/LFECP20					LFECP/EC33				
Ball Number	Ball Function	Bank	LVDS	Dual Function	Ball Number	Ball Function	Bank	LVDS	Dual Function
L24	PR17A	2	T		L24	PR29A	2	T	
K25	PR16B	2	C		K25	PR28B	2	C	
J25	PR16A	2	T		J25	PR28A	2	T	
J26	PR15B	2	C		J26	PR27B	2	C	
H26	PR15A	2	T		H26	PR27A	2	T	
H25	PR14B	2	C		H25	PR26B	2	C	
GND	GND2	2			GND	GND2	2		
J24	PR14A	2	T		J24	PR26A	2	T	
K21	PR13B	2	C		K21	PR25B	2	C	
K22	PR13A	2	T		K22	PR25A	2	T	
K20	PR12B	2	C		K20	PR24B	2	C	
J20	PR12A	2	T		J20	PR24A	2	T	
K23	PR11B	2	C		K23	PR23B	2	C	
K24	PR11A	2	T		K24	PR23A	2	T	RDQS23
J21	NC	-			J21	PR22B	2	C	
-	-	-			GND	GND2	2		
J22	NC	-			J22	PR22A	2	T	
J23	NC	-			J23	PR21B	2	C	
H22	NC	-			H22	PR21A	2	T	
G26	NC	-			G26	PR20B	2	C	
F26	NC	-			F26	PR20A	2	T	
E26	NC	-			E26	PR19B	2	C	
E25	NC	-			E25	PR19A	2	T	
F25	PR9B	2	C	RUM0_PLLC_FB_A	F25	PR17B	2	C	RUM0_PLLC_FB_A
GND	GND2	2			GND	GND2	2		
G25	PR9A	2	T	RUM0_PLLT_FB_A	G25	PR17A	2	T	RUM0_PLLT_FB_A
H23	PR8B	2	C	RUM0_PLLC_IN_A	H23	PR16B	2	C	RUM0_PLLC_IN_A
H24	PR8A	2	T	RUM0_PLLT_IN_A	H24	PR16A	2	T	RUM0_PLLT_IN_A
H21	PR7B	2	C		H21	PR15B	2	C	
G21	PR7A	2	T		G21	PR15A	2	T	
D26	PR6B	2	C		D26	PR14B	2	C	
D25	PR6A	2	T	RDQS6	D25	PR14A	2	T	RDQS14
F21	PR5B	2	C		F21	PR13B	2	C	
-	-	-			GND	GND2	2		
G22	PR5A	2	T		G22	PR13A	2	T	
G24	PR4B	2	C		G24	PR12B	2	C	
G23	PR4A	2	T		G23	PR12A	2	T	
C26	PR3B	2	C		C26	PR11B	2	C	
C25	PR3A	2	T		C25	PR11A	2	T	
F24	NC	-			F24	PR9B	2	C	
-	-	-			GND	GND2	2		
F23	NC	-			F23	PR9A	2	T	

LFECP/EC20, LFECP/EC33 Logic Signal Connections: 672 fpBGA (Cont.)

LFECP20/LFECP20					LFECP/EC33				
Ball Number	Ball Function	Bank	LVDS	Dual Function	Ball Number	Ball Function	Bank	LVDS	Dual Function
U12	GND	-			U12	GND	-		
U13	GND	-			U13	GND	-		
U14	GND	-			U14	GND	-		
U15	GND	-			U15	GND	-		
U16	GND	-			U16	GND	-		
U17	GND	-			U17	GND	-		
H10	VCC	-			H10	VCC	-		
H11	VCC	-			H11	VCC	-		
H16	VCC	-			H16	VCC	-		
H17	VCC	-			H17	VCC	-		
H18	VCC	-			H18	VCC	-		
H19	VCC	-			H19	VCC	-		
H8	VCC	-			H8	VCC	-		
H9	VCC	-			H9	VCC	-		
J18	VCC	-			J18	VCC	-		
J9	VCC	-			J9	VCC	-		
K8	VCC	-			K8	VCC	-		
L19	VCC	-			L19	VCC	-		
M19	VCC	-			M19	VCC	-		
N7	VCC	-			N7	VCC	-		
R20	VCC	-			R20	VCC	-		
R7	VCC	-			R7	VCC	-		
T19	VCC	-			T19	VCC	-		
V18	VCC	-			V18	VCC	-		
V8	VCC	-			V8	VCC	-		
V9	VCC	-			V9	VCC	-		
W10	VCC	-			W10	VCC	-		
W11	VCC	-			W11	VCC	-		
W16	VCC	-			W16	VCC	-		
W17	VCC	-			W17	VCC	-		
W18	VCC	-			W18	VCC	-		
W19	VCC	-			W19	VCC	-		
W8	VCC	-			W8	VCC	-		
W9	VCC	-			W9	VCC	-		
H12	VCCIO0	0			H12	VCCIO0	0		
H13	VCCIO0	0			H13	VCCIO0	0		
J10	VCCIO0	0			J10	VCCIO0	0		
J11	VCCIO0	0			J11	VCCIO0	0		
J12	VCCIO0	0			J12	VCCIO0	0		
J13	VCCIO0	0			J13	VCCIO0	0		
H14	VCCIO1	1			H14	VCCIO1	1		
H15	VCCIO1	1			H15	VCCIO1	1		

LFECP/EC20, LFECP/EC33 Logic Signal Connections: 672 fpBGA (Cont.)

LFECP20/LFECP20					LFECP/EC33				
Ball Number	Ball Function	Bank	LVDS	Dual Function	Ball Number	Ball Function	Bank	LVDS	Dual Function
J14	VCCIO1	1			J14	VCCIO1	1		
J15	VCCIO1	1			J15	VCCIO1	1		
J16	VCCIO1	1			J16	VCCIO1	1		
J17	VCCIO1	1			J17	VCCIO1	1		
K17	VCCIO2	2			K17	VCCIO2	2		
K18	VCCIO2	2			K18	VCCIO2	2		
L18	VCCIO2	2			L18	VCCIO2	2		
M18	VCCIO2	2			M18	VCCIO2	2		
N18	VCCIO2	2			N18	VCCIO2	2		
N19	VCCIO2	2			N19	VCCIO2	2		
P18	VCCIO3	3			P18	VCCIO3	3		
P19	VCCIO3	3			P19	VCCIO3	3		
R18	VCCIO3	3			R18	VCCIO3	3		
R19	VCCIO3	3			R19	VCCIO3	3		
T18	VCCIO3	3			T18	VCCIO3	3		
U18	VCCIO3	3			U18	VCCIO3	3		
V14	VCCIO4	4			V14	VCCIO4	4		
V15	VCCIO4	4			V15	VCCIO4	4		
V16	VCCIO4	4			V16	VCCIO4	4		
V17	VCCIO4	4			V17	VCCIO4	4		
W14	VCCIO4	4			W14	VCCIO4	4		
W15	VCCIO4	4			W15	VCCIO4	4		
V10	VCCIO5	5			V10	VCCIO5	5		
V11	VCCIO5	5			V11	VCCIO5	5		
V12	VCCIO5	5			V12	VCCIO5	5		
V13	VCCIO5	5			V13	VCCIO5	5		
W12	VCCIO5	5			W12	VCCIO5	5		
W13	VCCIO5	5			W13	VCCIO5	5		
P8	VCCIO6	6			P8	VCCIO6	6		
P9	VCCIO6	6			P9	VCCIO6	6		
R8	VCCIO6	6			R8	VCCIO6	6		
R9	VCCIO6	6			R9	VCCIO6	6		
T9	VCCIO6	6			T9	VCCIO6	6		
U9	VCCIO6	6			U9	VCCIO6	6		
K9	VCCIO7	7			K9	VCCIO7	7		
L9	VCCIO7	7			L9	VCCIO7	7		
M8	VCCIO7	7			M8	VCCIO7	7		
M9	VCCIO7	7			M9	VCCIO7	7		
N8	VCCIO7	7			N8	VCCIO7	7		
N9	VCCIO7	7			N9	VCCIO7	7		
G13	VCCAUX	-			G13	VCCAUX	-		
H20	VCCAUX	-			H20	VCCAUX	-		